Hall IC Series / Hall IC(Latch type)

Bipolar Detection Hall ICs

(With Polarity Discrimination Output)

BU52004GUL, BU52014HFV

●Description

The BU52004GUL and BU52014HFV are bipolar Hall ICs incorporating a polarity determination circuit that enables operation (output) on both the S- and N-poles, with the polarity judgment based on the output processing configuration. These Hall IC products can be in with movie, mobile phone and other applications involving crystal panels to detect the (front-back) location or determine the rotational direction of the panel.

●Features

1) Bipolar detection (polarity detection for both S and N features dual outputs)
2) Micropower operation (small current using intermittent operation method)
3) Ultra-compact CSP4 package(BU52004GUL)
4) Small outline package (BU52014HFV)
5) Line up of supply voltage
   For 1.8V Power supply voltage（BU52014HFV)
   For 3.0V Power supply voltage (BU52004GUL)
6) Polarity judgment and output on both poles (OUT1: S-pole output; OUT2: N-pole output)
7) High ESD resistance 8kV(HBM)

●Applications

Mobile phones, notebook computers, digital video camera, digital still camera, etc.

●Product Lineup

Product name	Supply voltage (V)	Operate point (mT)	Hysteresis (mT)	Period (ms)	Supply current (AVG.) (μA)	Output type	Package
BU52004GUL	2.40～3.30	+/-3.7 ※	0.8	50	8.0	CMOS	VCSP50L1
BU52014HFV	1.65～3.30	+/-3.0 ※	0.9	50	5.0	CMOS	HVSOF5

※Plus is expressed on the S-pole; minus on the N-pole

June 2008

●Absolute Maximum Ratings

BU52004GUL (Ta=25℃)

PARAMETERS	SYMBOL	LIMIT	UNIT
Power Supply Voltage	V_{DD}	-0.1～+4.5※1	V
Output Current	I_{OUT}	±1	mA
Power Dissipation	Pd	420※2	mW
Operating Temperature Range	T_{opr}	-40～+85	℃
Storage Temperature Range	T_{stg}	-40～+125	℃

※1. Not to exceed Pd
※2. Reduced by 4.20mW for each increase in Ta of 1℃ over 25℃
（mounted on 50mm×58mm Glass-epoxy PCB）

BU52014GUL (Ta=25℃)

PARAMETERS	SYMBOL	LIMIT	UNIT
Power Supply Voltage	V_{DD}	-0.1～+4.5※3	V
Output Current	I_{OUT}	±0.5	mA
Power Dissipation	Pd	536※4	mW
Operating Temperature Range	T_{opr}	-40～+85	℃
Storage Temperature Range	T_{stg}	-40～+125	℃

※3. Not to exceed Pd
※4. Reduced by 5.36mW for each increase in Ta of 1℃ over 25℃
（mounted on 70mm×70mm×1.6mm Glass-epoxy PCB）

●Magnetic, Electrical Characteristics

BU52004GUL (Unless otherwise specified, V_{DD}=3.0V, Ta=25℃)

PARAMETERS	SYMBOL	LIMIT			UNIT	CONDITIONS
		MIN	TYP	MAX		
Power Supply Voltage	V_{DD}	2.4	3.0	3.3	V	
Operate Point	B_{opS}	-	3.7	5.5	mT	OUTPUT : OUT1 (respond the south pole)
	B_{opN}	-5.5	-3.7	-		OUTPUT : OUT2 (respond the north pole)
Release Point	B_{rpS}	0.8	2.9	-	mT	OUTPUT : OUT1 (respond the south pole)
	B_{rpN}	-	-2.9	-0.8		OUTPUT : OUT2 (respond the north pole)
Hysteresis	B_{hysS}	-	0.8	-	mT	
	B_{hysN}	-	0.8	-		
Period	T_p	-	50	100	ms	
Output High Voltage	V_{OH}	V_{DD} -0.4	-	-	V	B_{rpN}<B<B_{rpS} ※5 I_{OUT} =-1.0mA
Output Low Voltage	V_{OL}	-	-	0.4	V	B<B_{opN}, B_{opS}<B ※5 I_{OUT} =+1.0mA
Supply Current	$I_{DD(AVG)}$	-	8	12	μA	Average
Supply Current During Startup Time	$I_{DD(EN)}$	-	4.7	-	mA	During Startup Time Value
Supply Current During Standby Time	$I_{DD(DIS)}$	-	3.8	-	μA	During Standby Time Value

※5. B = Magnetic flux density
1mT=10Gauss
Positive (“+”) polarity flux is defined as the magnetic flux from south pole which is direct toward to the branded face of the sensor.
After applying power supply, it takes one cycle of period (T_P) to become definite output.
Radiation hardiness is not designed.

BU52014HFV (Unless otherwise specified, V_{DD}＝1.80V, Ta＝25℃)

PARAMETERS	SYMBOL	LIMIT			UNIT	CONDITIONS
		MIN	TYP	MAX		
Power Supply Voltage	V_{DD}	1.65	1.80	3.30	V	
Operate Point	B_{opS}	-	3.0	5.0	mT	OUTPUT：OUT1 (respond the south pole)
	B_{opN}	-5.0	-3.0	-		OUTPUT：OUT2 (respond the north pole)
Release Point	B_{rpS}	0.6	2.1	-	mT	OUTPUT：OUT1 (respond the south pole)
	B_{rpN}	-	-2.1	-0.6		OUTPUT：OUT2 (respond the north pole)
Hysteresis	B_{hysS}	-	0.9	-	mT	
	B_{hysN}	-	0.9	-		
Period	T_p	-	50	100	ms	
Output High Voltage	V_{OH}	V_{DD} -0.2	-	-	V	B_{rpN}<B<B_{rpS} ※6 I_{OUT} =-0.5mA
Output Low Voltage	V_{OL}	-	-	0.2	V	B<B_{opN}, B_{opS}<B ※6 I_{OUT} =+0.5mA
Supply Current 1	$I_{DD1(AVG)}$	-	5	8	μA	V_{DD}=1.8V, Average
Supply Current During Startup Time 1	$I_{DD1(EN)}$	-	2.8	-	mA	V_{DD}=1.8V, During Startup Time Value
Supply Current During Standby Time 1	$I_{DD1(DIS)}$	-	1.8	-	μA	V_{DD}=1.8V, During Standby Time Value
Supply Current 2	$I_{DD2(AVG)}$	-	8	12	μA	V_{DD}=2.7V, Average
Supply Current During Startup Time 2	$I_{DD2(EN)}$	-	4.5	-	mA	V_{DD}=2.7V, During Startup Time Value
Supply Current During Standby Time 2	$I_{DD2(DIS)}$	-	4.0	-	μA	V_{DD}=2.7V, During Standby Time Value

※6. B = Magnetic flux density

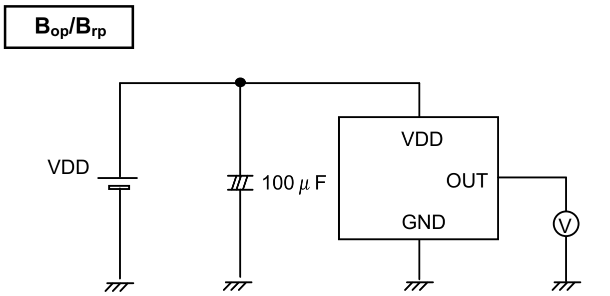
1mT=10Gauss

Positive (“+”) polarity flux is defined as the magnetic flux from south pole which is direct toward to the branded face of the sensor.

After applying power supply, it takes one cycle of period (T_P) to become definite output.

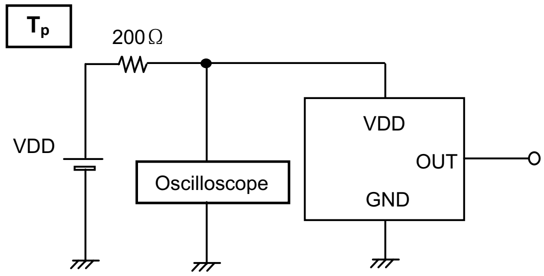
Radiation hardiness is not designed.

●Figure of measurement circuit



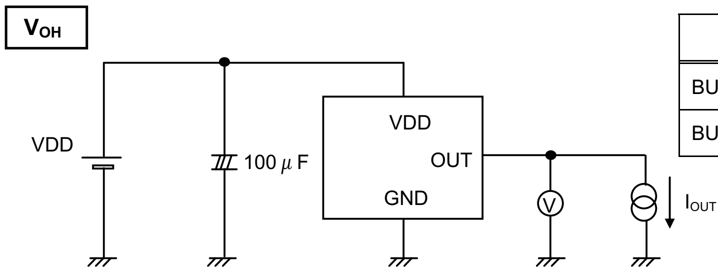
Bop and Brp are measured with applying the magnetic field from the outside.

Fig.1 B_{op},B_{rp} measurement circuit



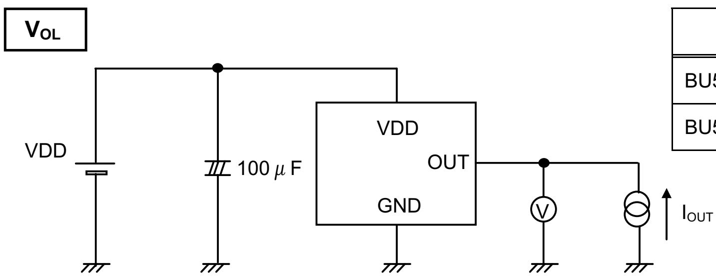
The period is monitored by Oscilloscope.

Fig.2 T_p measurement circuit



Product Name	I_{OUT}
BU52004GUL	1.0mA
BU52014HFV	0.5mA

Fig.3 V_{OH} measurement circuit



Product Name	I_{OUT}
BU52004GUL	1.0mA
BU52014HFV	0.5mA

Fig.4 V_{OL} measurement circuit

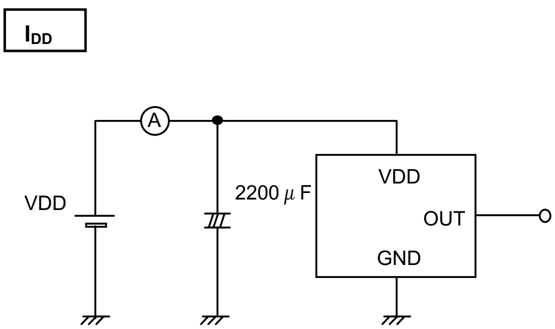


Fig.5 I_{DD} measurement circuit

●Technical (Reference) Data

BU52004GUL (V_{DD}=2.4～3.3V type)

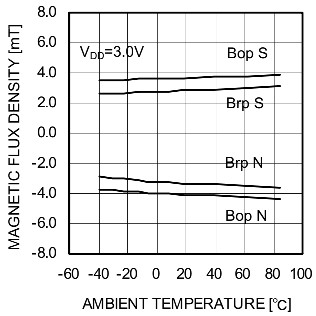


Fig.6 Bop,Brp – Ambient temperature

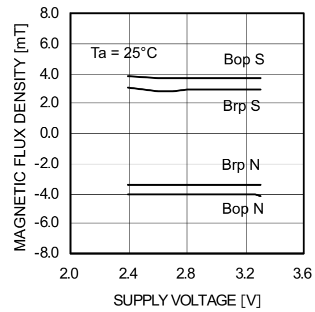


Fig.7 Bop,Brp – Supply voltage

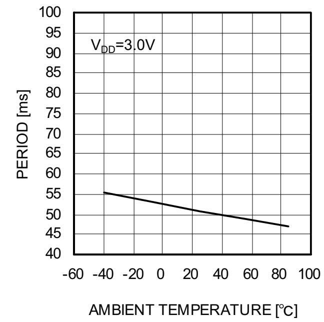


Fig.8 T_P– Ambient temperature

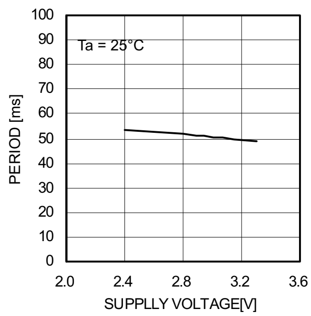


Fig.9 T_P – Supply voltage

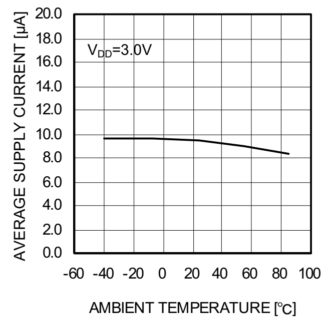


Fig.10 I_{DD} – Ambient temperature

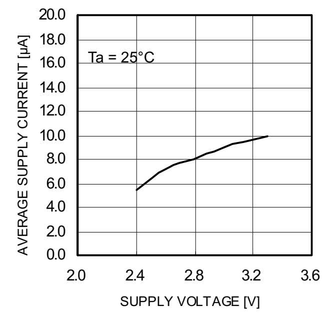


Fig.11 I_{DD} – Supply voltage

BU52014HFV (V_{DD}=1.65～3.3V type)

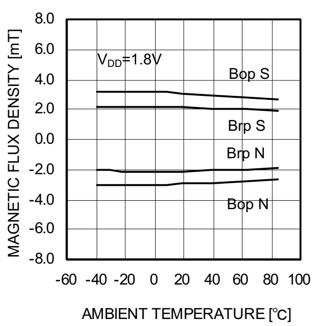


Fig.12 Bop,Brp – Ambient temperature

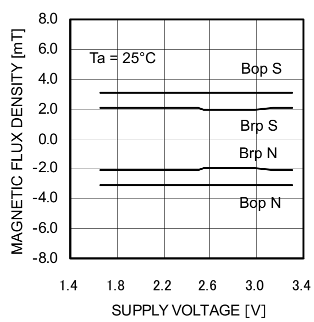


Fig.13 Bop,Brp – Supply voltage

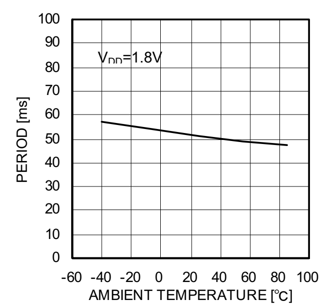


Fig.14 T_P– Ambient temperature

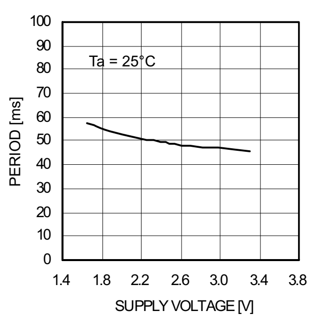


Fig.15 T_P– Supply voltage

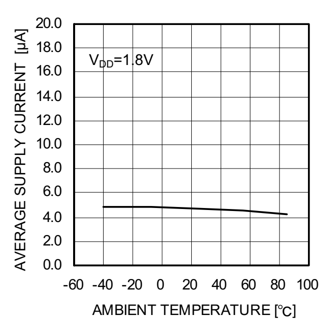


Fig.16 I_{DD} – Ambient temperature

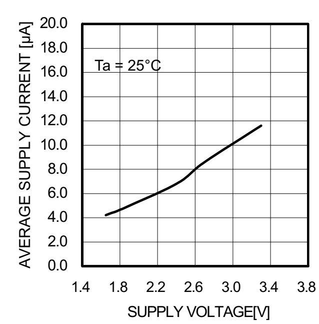
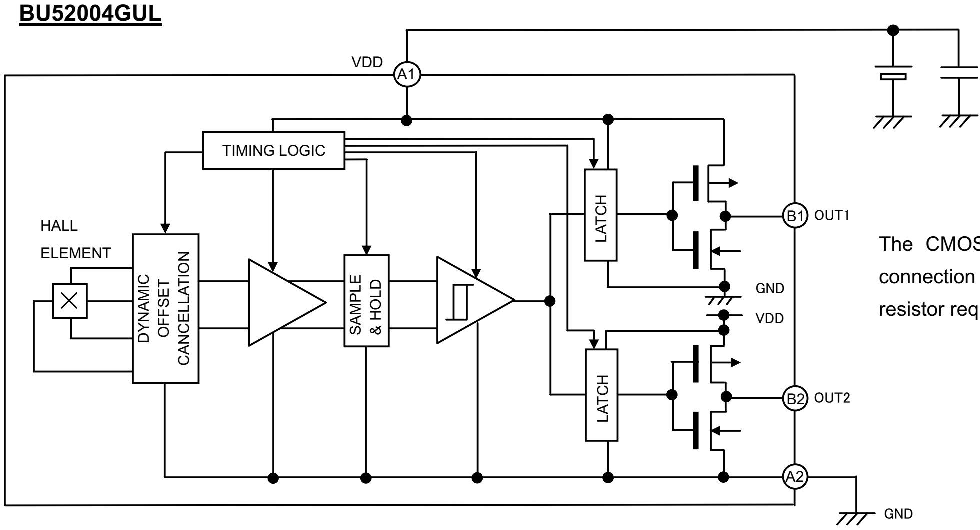


Fig.17 I_{DD} – Supply voltage

●Block Diagram

BU52004GUL



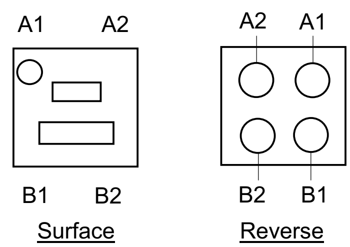
0.1 μ F

Adjust the bypass capacitor value as necessary, according to voltage noise conditions, etc.

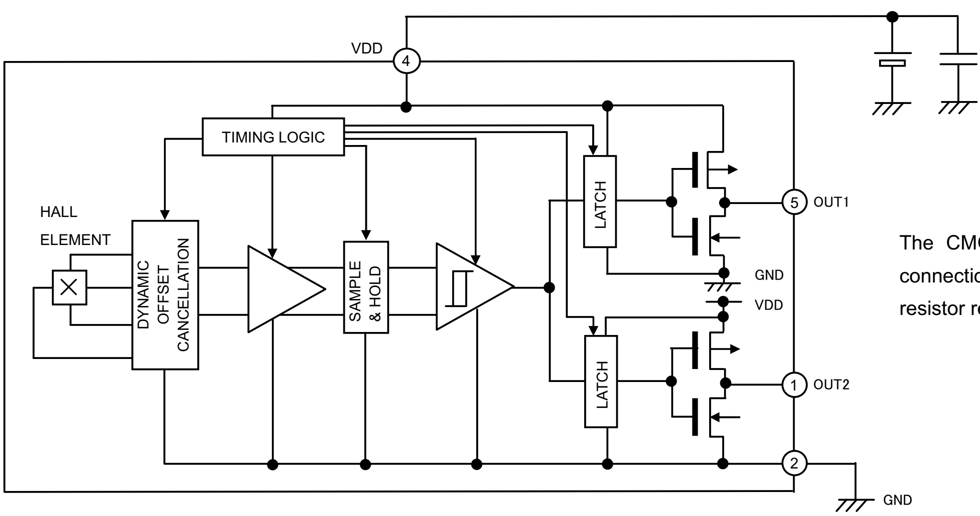
The CMOS output terminals enable direct connection to the PC, with no external pull-up resistor required.

Fig.18

PIN No.	PIN NAME	FUNCTION	COMMENT
A1	VDD	POWER SUPPLY	
A2	GND	GROUND	
B1	OUT1	OUTPUT(respond the south pole)	
B2	OUT2	OUTPUT(respond the north pole)	



BU52014HFV



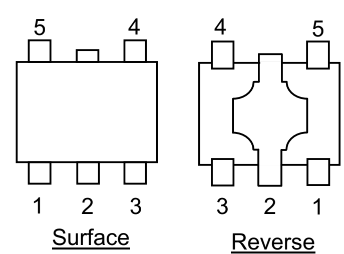
0.1 μ F

Adjust the bypass capacitor value as necessary, according to voltage noise conditions, etc.

The CMOS output terminals enable direct connection to the PC, with no external pull-up resistor required.

Fig.19

PIN No.	PIN NAME	FUNCTION	COMMENT
1	OUT2	OUTPUT (respond the north pole)	
2	GND	GROUND	
3	N.C.		OPEN or Short to GND.
4	VDD	POWER SUPPLY	
5	OUT1	OUTPUT (respond the south pole)	



● Description of Operations

Micropower Operation (Small current using intermittent action)

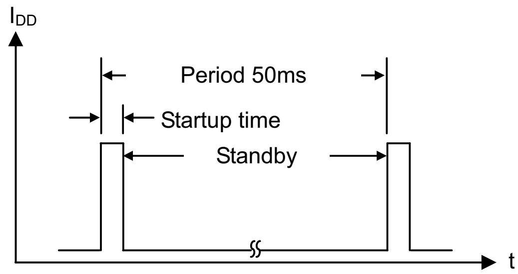


Fig.20

The dual output bipolar detection Hall IC adopts an intermittent operation method to save energy. At startup, the Hall elements, amp, comparator and other detection circuits power ON and magnetic detection begins. During standby, the detection circuits power OFF, thereby reducing current consumption. The detection results are held while standby is active, and then output.

Reference period: 50ms (MAX100ms)
Reference startup time: 48 μ s

(Offset Cancelation)

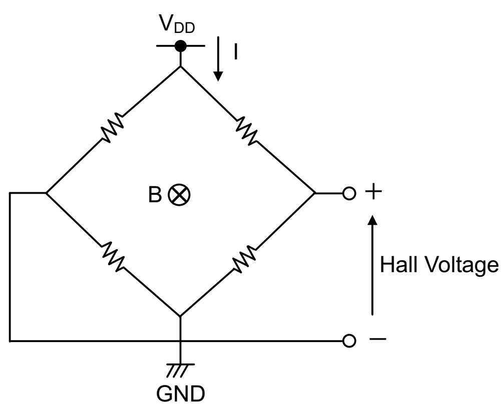


Fig.21

The Hall elements form an equivalent Wheatstone (resistor) bridge circuit. Offset voltage may be generated by a differential in this bridge resistance, or can arise from changes in resistance due to package or bonding stress. A dynamic offset cancellation circuit is employed to cancel this offset voltage.
When Hall elements are connected as shown in Fig. 21 and a magnetic field is applied perpendicular to the Hall elements, voltage is generated at the mid-point terminal of the bridge. This is known as Hall voltage.
Dynamic cancellation switches the wiring (shown in the figure) to redirect the current flow to a 90˚ angle from its original path, and thereby cancels the Hall voltage.
The magnetic signal (only) is maintained in the sample/hold circuit during the offset cancellation process and then released.

(Magnetic Field Detection Mechanism)

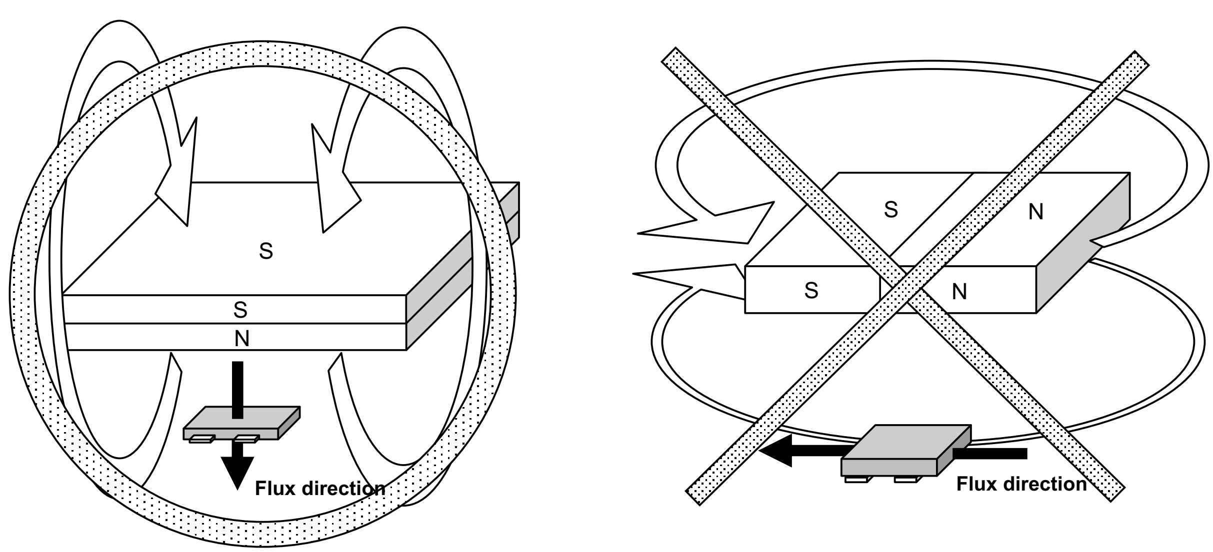


Fig.22

The Hall IC cannot detect magnetic fields that run horizontal to the package top layer.
Be certain to configure the Hall IC so that the magnetic field is perpendicular to the top layer.

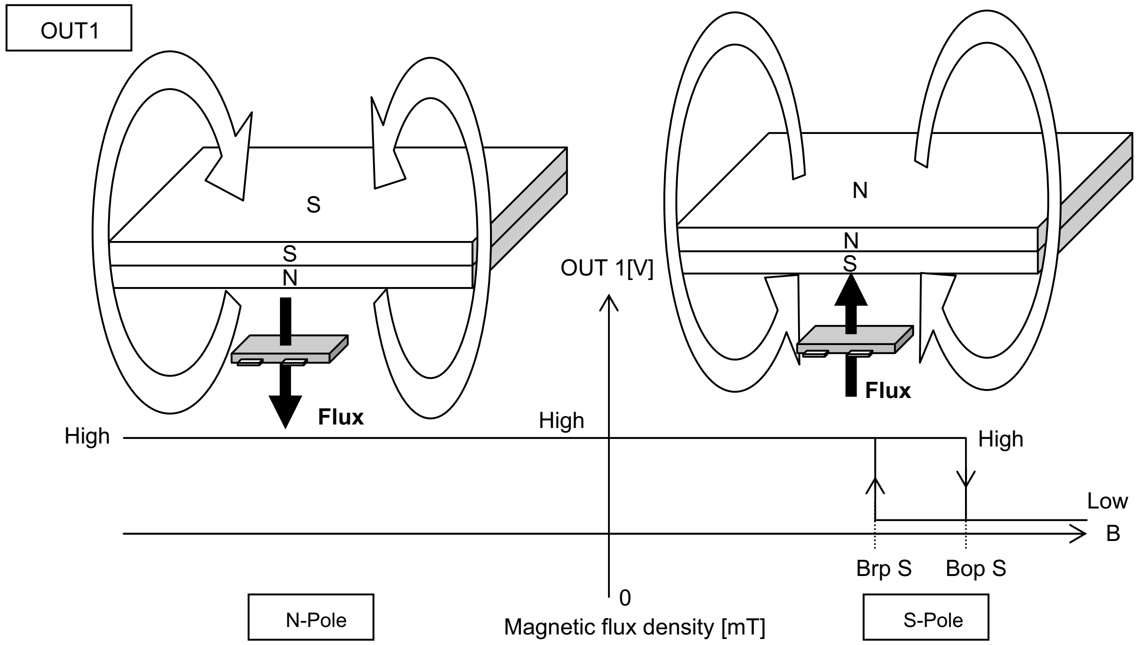


Fig.23 S-Pole Detection

The OUT1 pin detects and outputs for the S-pole only. Since it is unipolar, it does not recognize the N-pole.

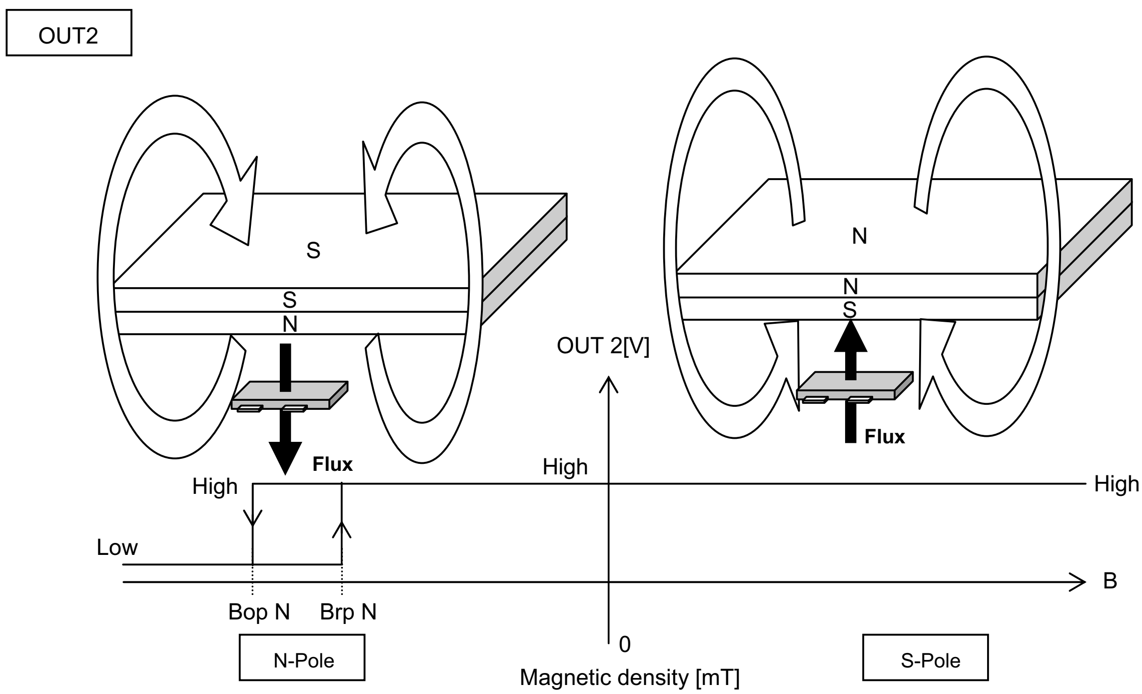


Fig.24 N-Pole Detection

The OUT2 pin detects and outputs for the N-pole only. Since it is unipolar, it does not recognize the S-pole.

The dual output bipolar detection Hall IC detects magnetic fields running perpendicular to the top surface of the package. There is an inverse relationship between magnetic flux density and the distance separating the magnet and the Hall IC: when distance increases magnetic density falls. When it drops below the operate point (Bop), output goes HIGH. When the magnet gets closer to the IC and magnetic density rises, to the operate point, the output switches LOW. In LOW output mode, the distance from the magnet to the IC increases again until the magnetic density falls to a point just below Bop, and output returns HIGH. (This point, where magnetic flux density restores HIGH output, is known as the release point, Brp.) This detection and adjustment mechanism is designed to prevent noise, oscillation and other erratic system operation.

●Intermittent Operation at Power ON

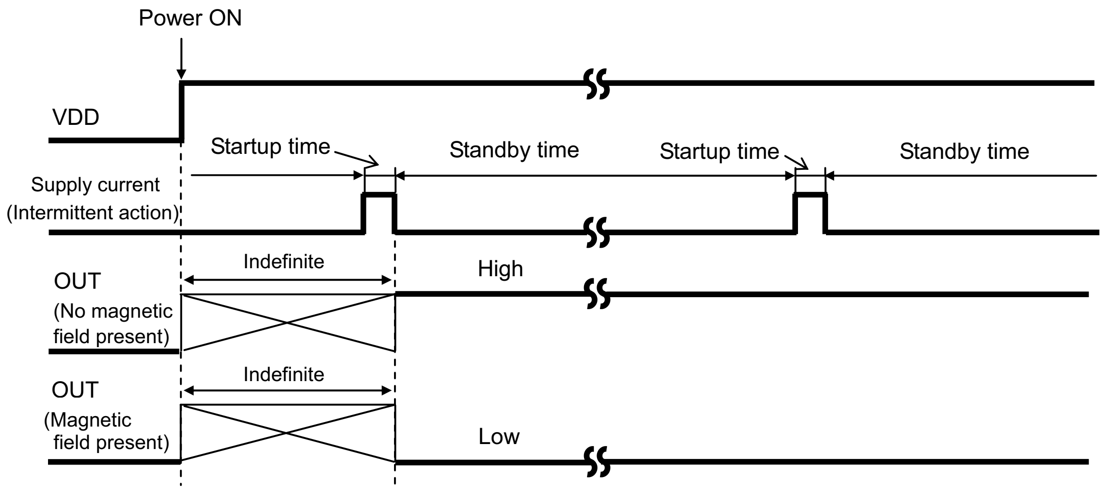


Fig.25

The dual output bipolar detection Hall IC adopts an intermittent operation method in detecting the magnetic field during startup, as shown in Fig. 25. It outputs to the appropriate terminal based on the detection result and maintains the output condition during the standby period. The time from power ON until the end of the initial startup period is an indefinite interval, but it cannot exceed the maximum period, 100ms. To accommodate the system design, the Hall IC output read should be programmed within 100ms of power ON, but after the time allowed for the period ambient temperature and supply voltage.

●Magnet Selection

Of the two representative varieties of permanent magnet, neodymium generally offers greater magnetic power per volume than ferrite, thereby enabling the highest degree of miniaturization, Thus, neodymium is best suited for small equipment applications. Fig. 26 shows the relation between the size (volume) of a neodymium magnet and magnetic flux density. The graph plots the correlation between the distance (L) from three versions of a 4mm X 4mm cross-section neodymium magnet (1mm, 2mm, and 3mm thick) and magnetic flux density. Fig. 27 shows Hall IC detection distance – a good guide for determining the proper size and detection distance of the magnet. Based on the BU52014HFV operating point max 5.0 mT, the minimum detection distance for the 1mm, 2mm and 3mm magnets would be 7.6mm, 9.22mm, and 10.4mm, respectively. To increase the magnet's detection distance, either increase its thickness or sectional area.

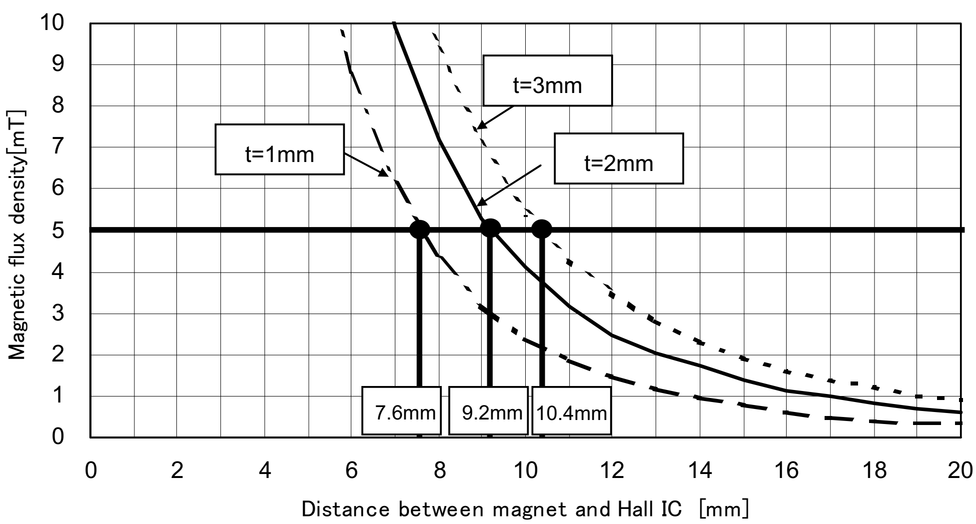
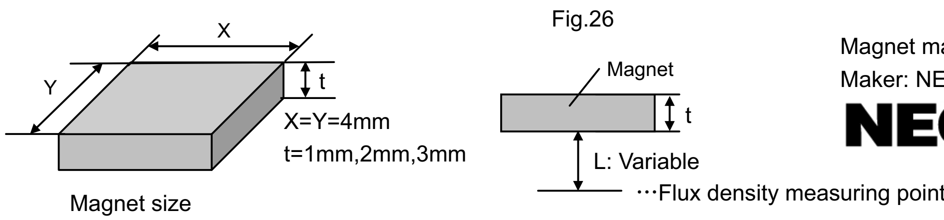


Fig.26



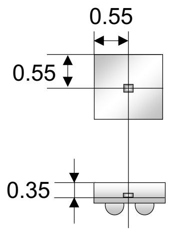
Magnet material: NEOMAX-44H (material)
Maker: NEOMAX CO.,LTD.

NEOMAX

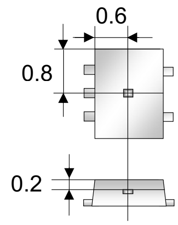
Fig.27 Magnet Dimensions and Flux Density Measuring Point

●Position of the Hall Effect IC(Reference)

VCSP50L1



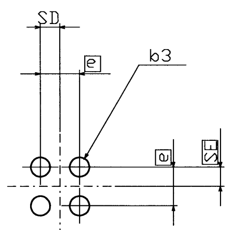
HVSOF5



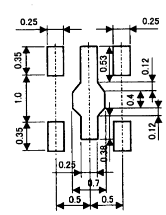
(UNIT：mm)

●Footprint dimensions (Optimize footprint dimensions to the board design and soldering condition)

VCSP50L1



HVSOF5



照合文字	寸法 (標準値)
e	0.50
b3	0.25
SD	0.25
SE	0.25

(UNIT：mm)

●Terminal Equivalent Circuit Diagram

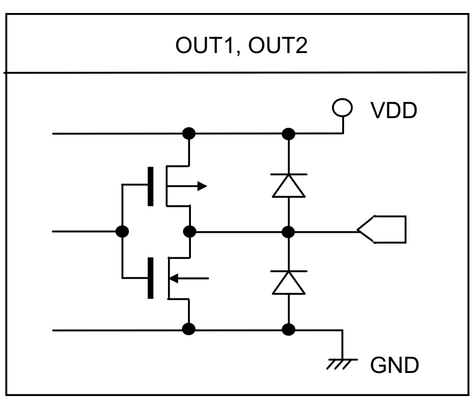


Fig.28

Because they are configured for CMOS (inverter) output, the output pins require no external resistance and allow direct connection to the PC. This, in turn, enables reduction of the current that would otherwise flow to the external resistor during magnetic field detection, and supports overall low current (micropower) operation.

●Operation Notes

1） Absolute maximum ratings

Exceeding the absolute maximum ratings for supply voltage, operating conditions, etc. may result in damage to or destruction of the IC. Because the source (short mode or open mode) cannot be identified if the device is damaged in this way, it is important to take physical safety measures such as fusing when implementing any special mode that operates in excess of absolute rating limits.

2） GND voltage

Make sure that the GND terminal potential is maintained at the minimum in any operating state, and is always kept lower than the potential of all other pins.

3） Thermal design

Use a thermal design that allows for sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

4） Pin shorts and mounting errors

Use caution when positioning the IC for mounting on printed circuit boards. Mounting errors, such as improper positioning or orientation, may damage or destroy the device. The IC may also be damaged or destroyed if output pins are shorted together, or if shorts occur between the output pin and supply pin or GND.

5） Positioning components in proximity to the Hall IC and magnet

Positioning magnetic components in close proximity to the Hall IC or magnet may alter the magnetic field, and therefore the magnetic detection operation. Thus, placing magnetic components near the Hall IC and magnet should be avoided in the design if possible. However, where there is no alternative to employing such a design, be sure to thoroughly test and evaluate performance with the magnetic component(s) in place to verify normal operation before implementing the design.

6） Slide-by position sensing

Fig.29 depicts the slide-by configuration employed for position sensing. Note that when the gap (d) between the magnet and the Hall IC is narrowed, the reverse magnetic field generated by the magnet can cause the IC to malfunction. As seen in Fig.30, the magnetic field runs in opposite directions at Point A and Point B. Since the dual output bipolar detection Hall IC can detect the S-pole at Point A and the N-pole at Point B, it can wind up switching output ON as the magnet slides by in the process of position detection. Fig. 31 plots magnetic flux density during the magnet slide-by. Although a reverse magnetic field was generated in the process, the magnetic flux density decreased compared with the center of the magnet. This demonstrates that slightly widening the gap (d) between the magnet and Hall IC reduces the reverse magnetic field and prevents malfunctions.

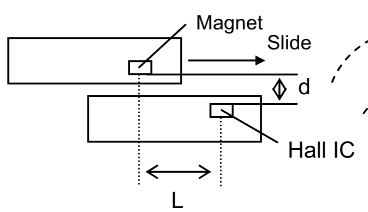


Fig.29

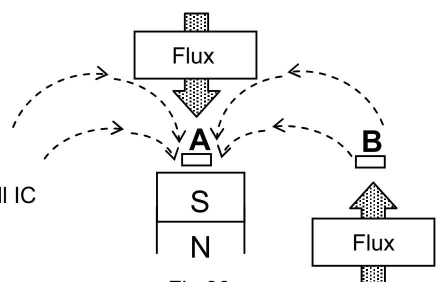


Fig.30

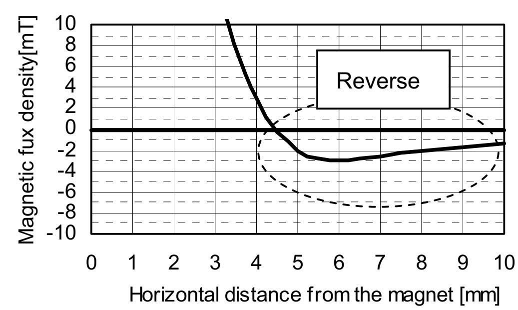


Fig.31

7） Operation in strong electromagnetic fields

Exercise extreme caution about using the device in the presence of a strong electromagnetic field, as such use may cause the IC to malfunction.

8) Common impedance

Make sure that the power supply and GND wiring limits common impedance to the extent possible by, for example, employing short, thick supply and ground lines. Also, take measures to minimize ripple such as using an inductor or capacitor.

9） GND wiring pattern

When both a small-signal GND and high-current GND are provided, single-point grounding at the reference point of the set PCB is recommended, in order to separate the small-signal and high-current patterns, and to ensure that voltage changes due to the wiring resistance and high current do not cause any voltage fluctuation in the small-signal GND. In the same way, care must also be taken to avoid wiring pattern fluctuations in the GND wiring pattern of external components.

10） Exposure to strong light

Exposure to halogen lamps, UV and other strong light sources may cause the IC to malfunction. If the IC is subject to such exposure, provide a shield or take other measures to protect it from the light. In testing, exposure to white LED and fluorescent light sources was shown to have no significant effect on the IC.

11) Power source design

Since the IC performs intermittent operation, it has peak current when it’s ON. Please taking that into account and under examine adequate evaluations when designing the power source.

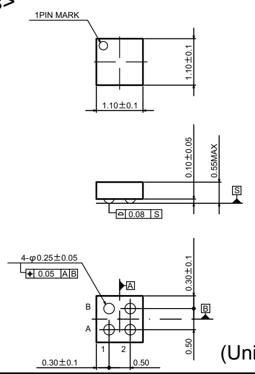
●Product Designations (Selecting a model name when ordering)

B	U		5	2	0	0	4		G	U	L	—	E	2

- B U: ROHM model
- 5 2 0 0 4: Part number
- G U L: Package type (VSCP50L1 : GUL, HVSOF5 : HFV)
- E 2: TR, E2 = Reel-wound embossed taping (VSCP50L1 : E2, HVSOF5 : TR)

VCSP50L1

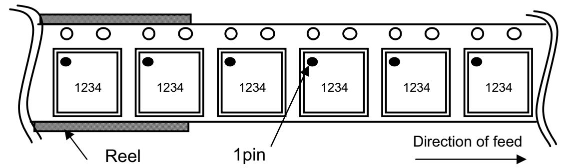
<Dimensions>



(Unit: mm)

< Tape/Reel Info >

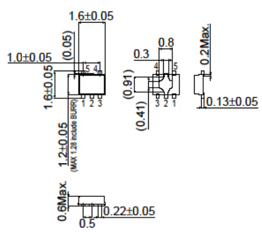
Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	E2 (Correct direction: With reel in the left hand, the 1pin of the product should be at the upper left. Pull tape out with the right hand)



※Orders are available in complete units only.

HVSOF5

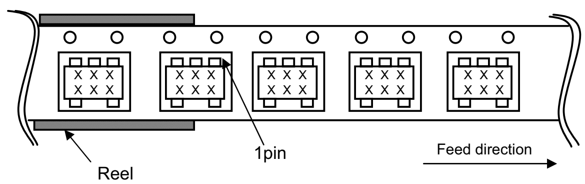
<Dimensions>



(Unit: mm)

< Tape/Reel Info >

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (Correct direction: With reel in the left hand, the 1pin of the product should be at the upper left. Pull tape out with the right hand)



※Orders are available in complete units only.

Excellence in Electronics

ROHM CO., LTD.

21, Saiin Mizosaki-cho, Ukyo-ku, Kyoto
615-8585, Japan
TEL: +81-75-311-2121 FAX: +81-75-315-0172
URL http: // www. rohm. com

Published by
LSI Business Promotion Dept.

Contact us for further information about the products.

San Diego	TEL: +1-858-625-3630	FAX: +1-858-625-3670	Shanghai	TEL: +86-21-6279-2727	FAX: +86-21-6247-2066
Atlanta	TEL: +1-770-754-5972	FAX: +1-770-754-0691	Hangzhou	TEL: +86-571-87658072	FAX: +86-571-87658071
Boston	TEL: +1-978-371-0382	FAX: +1-928-438-7164	Nanjing	TEL: +86-25-8689-0015	FAX: +86-25-8689-0393
Chicago	TEL: +1-847-368-1006	FAX: +1-847-368-1008	Ningbo	TEL: +86-574-87654201	FAX: +86-574-87654208
Dallas	TEL: +1-469-287-5366	FAX: +1-469-362-7973	Qingdao	TEL: +86-532-5779-312	FAX:+86-532-5779-653
Denver	TEL: +1-303-708-0908	FAX: +1-303-708-0858	Suzhou	TEL: +86-512-6807-1300	FAX: +86-512-6807-2300
Detroit	TEL: +1-248-348-9920	FAX: +1-248-348-9942	Wuxi	TEL: +86-510-82702693	FAX: +86-510-82702992
Nashville	TEL: +1-615-620-6700	FAX: +1-615-620-6702	Shenzhen	TEL: +86-755-8307-3008	FAX: +86-755-8307-3003
Mexico	TEL: +52-33-3123-2001	FAX: +52-33-3123-2002	Dongguan	TEL: +86-769-8393-3320	FAX: +86-769-8398-4140
Düsseldorf	TEL: +49-2154-9210	FAX: +49-2154-921400	Fuzhou	TEL: +86-591-8801-8698	FAX: +86-591-8801-8690
Munich	TEL: +49-8161-48310	FAX: +49-8161-483120	Guangzhou	TEL: +86-20-8364-9796	FAX: +86-20-8364-9707
Stuttgart	TEL: +49-711-72723710	FAX: +49-711-72723720	Huizhou	TEL: +86-752-205-1054	FAX: +86-752-205-1059
France	TEL: +33-1-5697-3060	FAX: +33-1-5697-3080	Xiamen	TEL: +86-592-238-5705	FAX: +86-592-239-8380
United Kingdom	TEL: +44-1-908-306700	FAX: +44-1-908-235788	Zhuhai	TEL: +86-756-3232-480	FAX: +86-756-3232-460
Denmark	TEL: +45-3694-4739	FAX: +45-3694-4789	Hong Kong	TEL: +852-2-740-6262	FAX: +852-2-375-8971
Barcelona	TEL: +34-9375-24320	FAX: +34-9375-24410	Taipei	TEL: +886-2-2500-6956	FAX: +886-2-2503-2869
Hungary	TEL: +36-1-4719338	FAX: +36-1-4719339	Kaohsiung	TEL: +886-7-237-0881	FAX: +886-7-238-7332
Poland	TEL: +48-22-5757213	FAX: +48-22-5757001	Singapore	TEL: +65-6332-2322	FAX: +65-6332-5662
Russia	TEL: +7-95-980-6755	FAX: +7-95-937-8290	Philippines	TEL: +63-2-807-6872	FAX: +63-2-809-1422
Seoul	TEL: +82-2-8182-700	FAX: +82-2-8182-715	Thailand	TEL: +66-2-254-4890	FAX: +66-2-256-6334
Masan	TEL: +82-55-240-6234	FAX: +82-55-240-6236	Kuala Lumpur	TEL: +60-3-7958-8355	FAX: +60-3-7958-8377
Dalian	TEL: +86-411-8230-8549	FAX: +86-411-8230-8537	Penang	TEL: +60-4-2286453	FAX: +60-4-2286452
Beijing	TEL: +86-10-8525-2483	FAX: +86-10-8525-2489	Kyoto	TEL: +81-75-365-1218	FAX: +81-75-365-1228
Tianjin	TEL: +86-22-23029181	FAX: +86-22-23029183	Yokohama	TEL: +81-45-476-2290	FAX: +81-45-476-2295

Catalog No.08T156A '08.6 ROHM © 1000 NZ

Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the product described in this document are for reference only. Upon actual use, therefore, please request that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, no express or implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).
Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.
It is our top priority to supply products with the utmost quality and reliability. However, there is always a chance of failure due to unexpected factors. Therefore, please take into account the derating characteristics and allow for sufficient safety features, such as extra margin, anti-flammability, and fail-safe measures when designing in order to prevent possible accidents that may result in bodily harm or fire caused by component failure. ROHM cannot be held responsible for any damages arising from the use of the products under conditions out of the range of the specifications or due to non-compliance with the NOTES specified in this catalog.

Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact your nearest sales office.

ROHM Customer Support System — **THE AMERICAS** / **EUROPE** / **ASIA** / **JAPAN**

www.rohm.com — **Contact us** : webmaster@rohm.co.jp

ROHM CO., LTD. 21 Saiin Mizosaki-cho, Ukyo-ku, Kyoto 615-8585, Japan
TEL : +81-75-311-2121
FAX : +81-75-315-0172